# 2SC3975

### Silicon NPN triple diffusion planar type

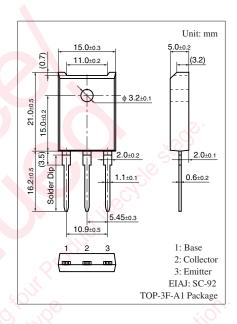
For high breakdown voltage high-speed switching

#### Features

- High-speed switching
- $\bullet$  High collector-base voltage (Emitter open)  $V_{CBO}$
- Wide safe operation area
- Satisfactory linearity of forward current transfer ratio  $h_{FE}$
- Full-pack package which can be installed to the heat sink with one screw

#### Absolute Maximum Ratings $T_C = 25^{\circ}C$

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Parameter	Symbol	Rating	Unit	
Collector-base voltage (Emitter open)	V <sub>CBO</sub>	800	V	
Collector-emitter voltage (E-B short)	V <sub>CES</sub>	800	V	
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	500	V	
Emitter-base voltage (Collector open)	V <sub>EBO</sub>	8	v	
Base current	I <sub>B</sub>	5	Α	
Collector current	I <sub>C</sub>	10	А	
Peak collector current	I <sub>CP</sub>	20	A	
Collector power dissipation	P <sub>C</sub>	100	W	
$T_a = 25^{\circ}C$		3.0		
Junction temperature	Tj	150	°C	
Storage temperature	T <sub>stg</sub>	-55 to +150	°C	

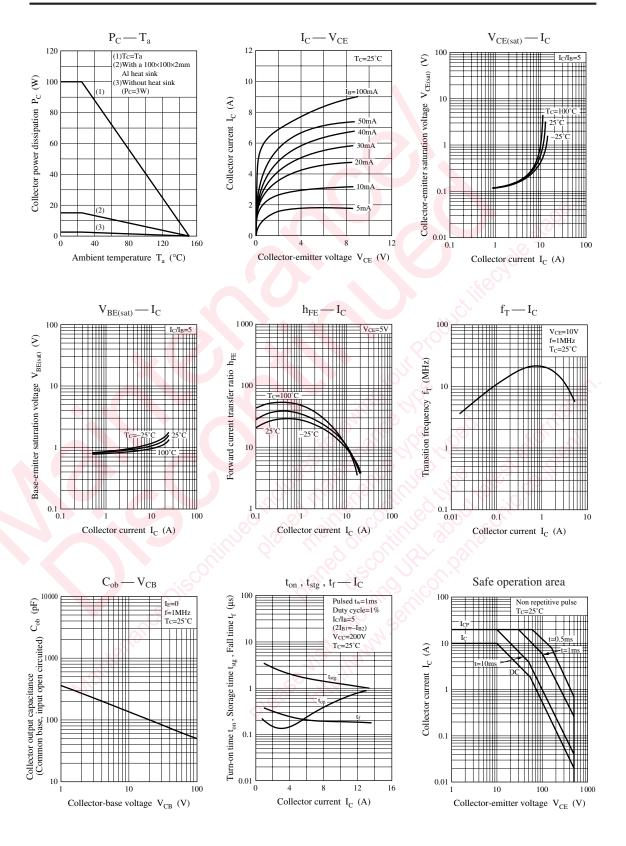


#### Electrical Characteristics $T_C = 25^{\circ}C \pm 3^{\circ}C$

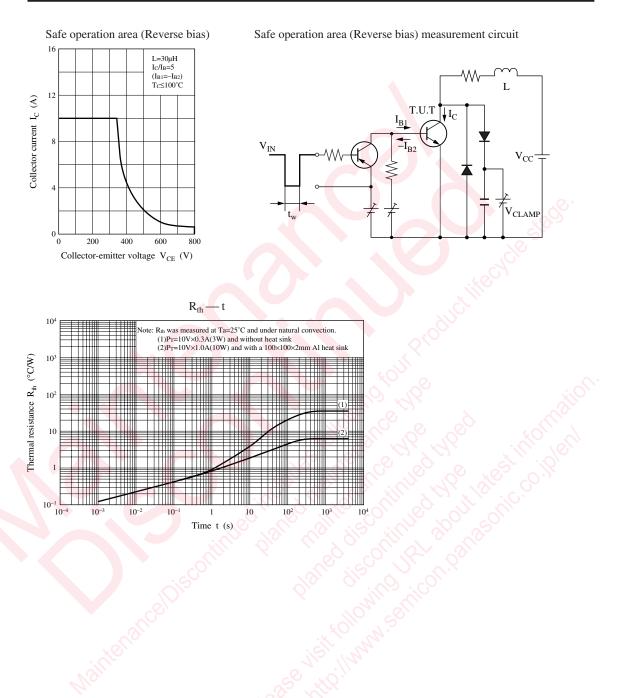
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	$I_{\rm C} = 10 \text{ mA}, I_{\rm B} = 0$	500			V
Collector-base cutoff current (Emitter open)	I <sub>CBO</sub>	$V_{CB} = 800 \text{ V}, I_E = 0$			100	μΑ
Emitter-base cutoff current (Collector open)	I <sub>EBO</sub>	$V_{EB} = 5 V, I_C = 0$			100	μΑ
Forward current transfer ratio	h <sub>FE1</sub>	$V_{CE} = 5 V, I_C = 0.1 A$	15			—
XOL	h <sub>FE2</sub>	$V_{CE} = 5 V, I_C = 6 A$	8			
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	$I_{\rm C} = 6 \text{ A}, I_{\rm B} = 1.2 \text{ A}$			1.0	V
Base-emitter saturation voltage	V <sub>BE(sat)</sub>	$I_{\rm C} = 6 \text{ A}, I_{\rm B} = 1.2 \text{ A}$			1.5	V
Transition frequency	f <sub>T</sub>	$V_{CE} = 10 \text{ V}, I_C = 0.5 \text{ A}, f = 1 \text{ MHz}$		20		MHz
Turn-on time	t <sub>on</sub>	$I_C = 6 A$			1.0	μs
Storage time	t <sub>stg</sub>	$I_{B1} = 1.2 \text{ A}, I_{B2} = -2.4 \text{ A}$			3.0	μs
Fall time	t <sub>f</sub>	$V_{CC} = 200 V$			0.3	μs

Note) Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

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